

# 6N137

## Super High Speed Response \*OPIC Photocoupler

### ■ Features

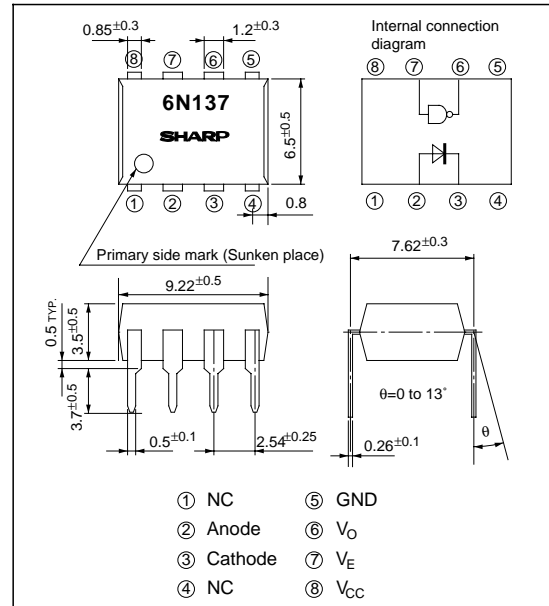
1. Super high speed response  
( $t_{PHL}$ ,  $t_{PLH}$  : TYP. 45ns at  $R_L=350\Omega$ )
2. Isolation voltage between input and output  
Viso(rms) : 2.5kV
3. Instantaneous common mode rejection voltage  
 $CM_H$  : TYP. 500V/ $\mu$ s
4. LSTTL and TTL compatible output
5. Recognized by UL, file No. E64380

### ■ Applications

1. High speed interfaces for computer peripherals, microcomputer systems
2. High speed line receivers
3. Noise reduction
4. Interfaces for data transmission equipment

### ■ Outline Dimensions

(Unit : mm)



\* "OPIC" (Optical IC) is a trademark of the SHARP Corporation.  
An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.

### ■ Absolute Maximum Ratings

(Ta=25°C)

	Parameter	Symbol	Rating	Unit
Input	*1 Forward current	$I_F$	20	mA
	*2 Peak forward current	$I_{FM}$	40	mA
	Reverse voltage	$V_R$	5	V
Output	*3 Supply voltage	$V_{CC}$	7	V
	*4 Enable voltage	$C_E$	5.5	V
	Output voltage	$V_O$	7	V
	Output current	$I_O$	50	mA
	Output collector power dissipation	$P_C$	85	mW
	*5 Isolation voltage	$V_{iso(rms)}$	2.5	kV
	Operating temperature	$T_{opr}$	0 to +70	°C
	Storage temperature	$T_{stg}$	-55 to +125	°C
	*6 Soldering temperature	$T_{sol}$	260	°C

\*1 Ta=0 to 70°C

\*2 Pulse width≤1ms

\*3 For 1 minute MAX.

\*4 Not exceed 500mV or more than supply voltage ( $V_{CC}$ )

\*5 AC for 1 minute, 40 to 60% RH

Apply the specific voltage between all the input electrode pins connected together and all the output electrode pins connected together.

\*6 2mm or more away from the lead base for 10 seconds

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Internet Internet address for Electronic Components Group <http://www.sharp.co.jp/ecg/>

## ■ Electro-optical Characteristics

(Ta=0 to +70°C unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Logic (1) output current	I <sub>OH</sub>	V <sub>CC</sub> =5.5V, V <sub>O</sub> =5.5V, I <sub>F</sub> =250 μA, V <sub>E</sub> =2.0V	–	2	250	μA
Logic (0) output voltage	V <sub>OL</sub>	V <sub>CC</sub> =5.5V, I <sub>F</sub> =5mA, V <sub>EH</sub> =2.0V, I <sub>OL</sub> (Sinking)=13mA	–	0.4	0.6	V
Logic (1) enable current	I <sub>EH</sub>	V <sub>CC</sub> =5.5V, V <sub>E</sub> =2.0V	–	–0.8	–	mA
Logic (0) enable current	I <sub>EL</sub>	V <sub>CC</sub> =5.5V, V <sub>E</sub> =0.5V	–	–1.2	–2.0	mA
Logic (1) supply current	I <sub>CCH</sub>	V <sub>CC</sub> =5.5V, I <sub>F</sub> =0mA, V <sub>E</sub> =0.5V	–	7	15	mA
Logic (0) supply current	I <sub>CCL</sub>	V <sub>CC</sub> =5.5V, I <sub>F</sub> =10mA, V <sub>E</sub> =0.5V	–	13	18	mA
<sup>*7</sup> Leak current	I <sub>LO</sub>	45%RH, Ta=25°C, t=5s, V <sub>LO</sub> =3.0kV DC	–	–	1.0	μA
<sup>*7</sup> Isolation resistance (input-output)	R <sub>LO</sub>	V <sub>LO</sub> =500V, Ta=25°C	–	1×10 <sup>12</sup>	–	Ω
<sup>*7</sup> Capacitance (input-output)	C <sub>LO</sub>	f=1MHz, Ta=25°C	–	0.6	–	pF
<sup>*8</sup> Input forward voltage	V <sub>F</sub>	I <sub>F</sub> =10mA, Ta=25°C	–	1.6	1.75	V
Input reverse voltage	BV <sub>R</sub>	I <sub>R</sub> =10μA, Ta=25°C	5	–	–	V
Input capacitance	C <sub>IN</sub>	V <sub>F</sub> =0, f=1MHz	–	60	–	pF

<sup>\*7</sup> Measured as 2-pin element. Connect pins 2 and 3 connect pins 5,6,7 and 8.

<sup>\*8</sup> At I<sub>F</sub>=10mA, V<sub>F</sub> decreases at the rate of 1.6mV/°C if the temperature goes up.

## ■ Switching Characteristics

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
<sup>*9</sup> Propagation delay time Output (0) → (1)	t <sub>PLH</sub>	Ta=25°C, R <sub>L</sub> =350Ω, C <sub>L</sub> =15pF, I <sub>F</sub> =7.5mA	–	45	75	ns
<sup>*9</sup> Propagation delay time Output (1) → (0)	t <sub>PHL</sub>	Ta=25°C, R <sub>L</sub> =350Ω, C <sub>L</sub> =15pF, I <sub>F</sub> =7.5mA	–	45	75	ns
Output rise-fall time (10 to 90%)	t <sub>r</sub> , t <sub>f</sub>	R <sub>L</sub> =350Ω, C <sub>L</sub> =15pF, I <sub>F</sub> =7.5mA	–	20, 30	–	ns
<sup>*10</sup> Enable propagation delay time (1) → (0)	t <sub>ELH</sub>	R <sub>L</sub> =350Ω, C <sub>L</sub> =15pF, I <sub>F</sub> =7.5mA, V <sub>EH</sub> =3.0V, V <sub>EL</sub> =0.5V	–	40	–	ns
<sup>*10</sup> Enable propagation delay time (0) → (1)	t <sub>EHL</sub>	R <sub>L</sub> =350Ω, C <sub>L</sub> =15pF, I <sub>F</sub> =7.5mA, V <sub>EH</sub> =3.0V, V <sub>EL</sub> =0.5V	–	15	–	ns
<sup>*11</sup> Instantaneous common mode rejection voltage "Output (1)"	CM <sub>H</sub>	V <sub>CM</sub> =10V, R <sub>L</sub> =350Ω, V <sub>O</sub> (min.)=2V, I <sub>F</sub> =0mA	–	500	–	V/μs
<sup>*11</sup> Instantaneous common mode rejection voltage "Output (0)"	CM <sub>L</sub>	V <sub>CM</sub> =10V, R <sub>L</sub> =350Ω, V <sub>O</sub> (max.)=0.8V, I <sub>F</sub> =5mA	–	–500	–	V/μs

<sup>\*9</sup> Refer to the Fig. 1.

<sup>\*10</sup> Refer to the Fig. 2.

<sup>\*11</sup> CM<sub>H</sub> represents a common mode voltage variation that can hold the output above (1) level (V<sub>O</sub>>2.0V).

CM<sub>L</sub> represents a common mode voltage variation that can hold the output above (0) level (V<sub>O</sub><0.8V)

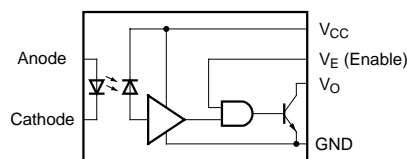
Note) Typical values are all at V<sub>CC</sub>=5V, Ta=25°C

## ■ Recommended Operating Conditions

Parameter	Symbol	MIN.	MAX.	Unit
Low level input current	I <sub>FL</sub>	0	250	μA
High level input current	I <sub>FH</sub>	7.0	15	mA
High level enable voltage	V <sub>EH</sub>	2.0	V <sub>CC</sub>	V
Low level enable voltage	V <sub>EL</sub>	0	0.8	V
Supply voltage	V <sub>CC</sub>	4.5	5.5	V
Fanout (TTL load)	N	–	8	–
Operating temperature	T <sub>opr</sub>	0	70	°C

- No necessary external pull-up resistor to hold enable input at high level.
- Connect a ceramic by-pass capacitor (0.01 to 0.1μF) between V<sub>CC</sub> and GND at the position within 1cm from pin.

## Circuit Block Diagram



## Truth Table

Input	Enable	Output
H	H	L
L	H	H
H	L	H
L	L	H

L : Logic (0) H : Logic (1)

Fig.1 Test Circuit for Propagation Delay Time

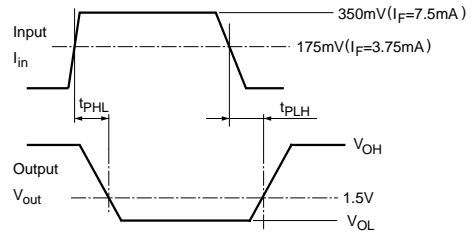
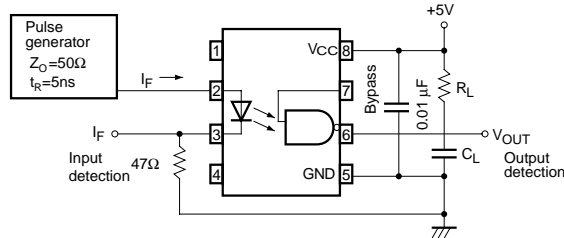


Fig.2 Test Circuit for Enable Propagation Delay Time

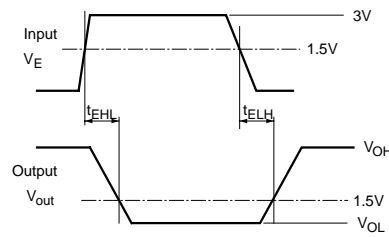
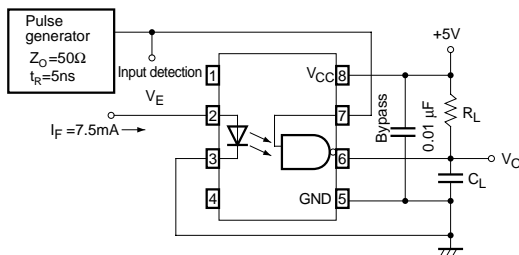


Fig.3 Test Circuit for Instantaneous Common Mode Rejection Voltage

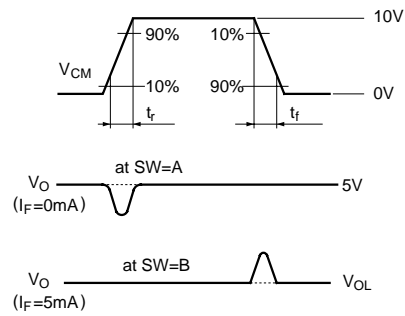
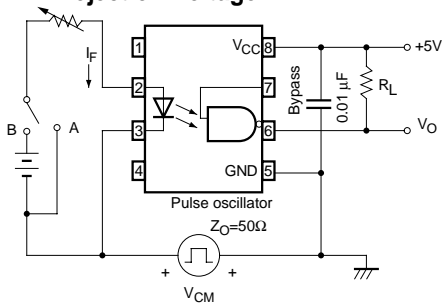


Fig. 4 Output Collector Power Dissipation vs. Ambient Temperature

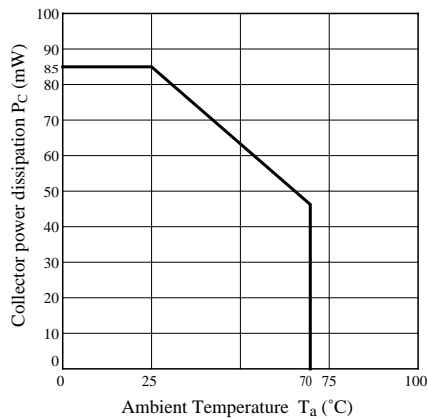
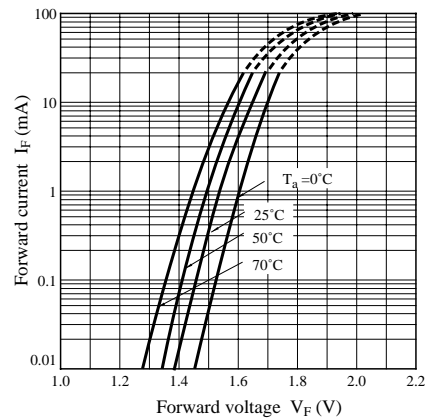
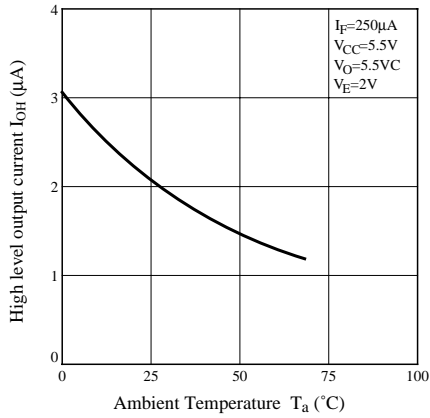


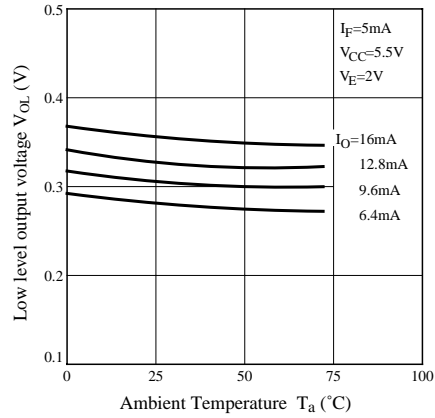
Fig. 5 Forward Current vs. Forward Voltage



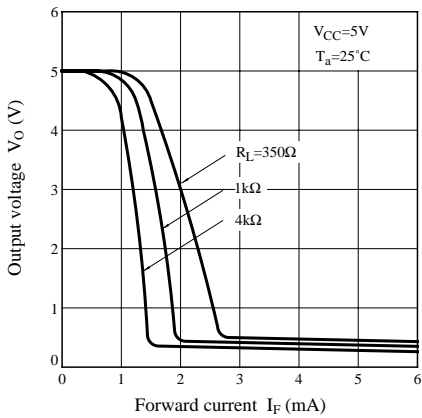
**Fig. 6 High Level Output Current vs. Ambient Temperature**



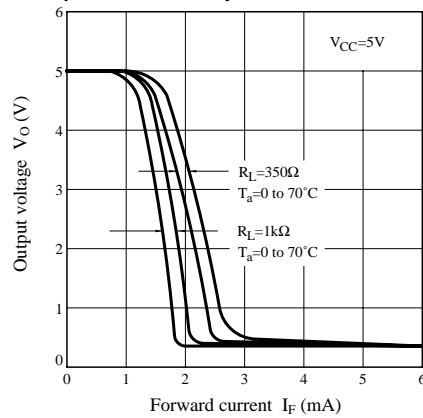
**Fig. 7 Low Level Output Voltage vs. Ambient Temperature**



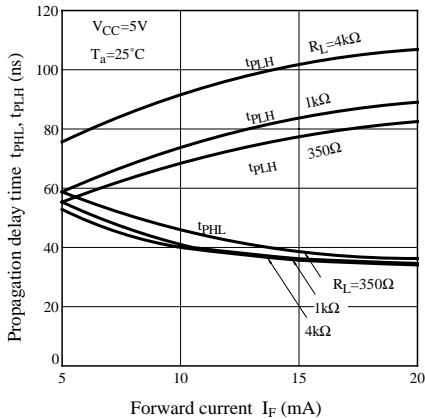
**Fig. 8-a Output Voltage vs. Forward Current**



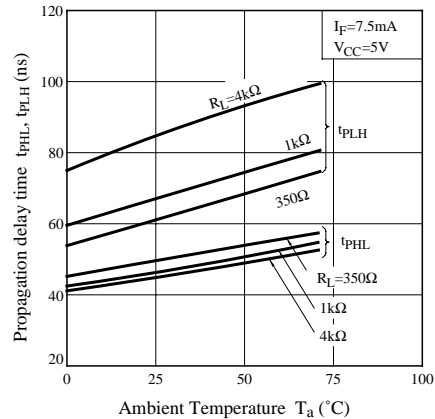
**Fig. 8-b Output Voltage vs. Forward Current (Ambient Temp. Characteristics)**



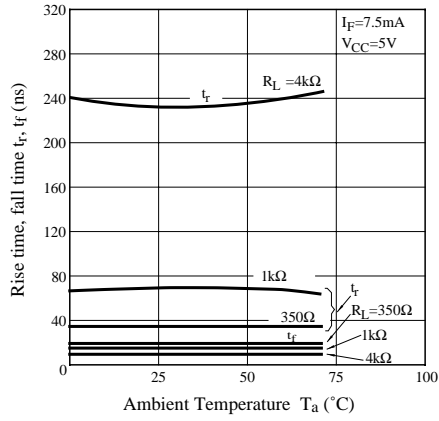
**Fig. 9 Propagation Delay Time vs. Forward Current**



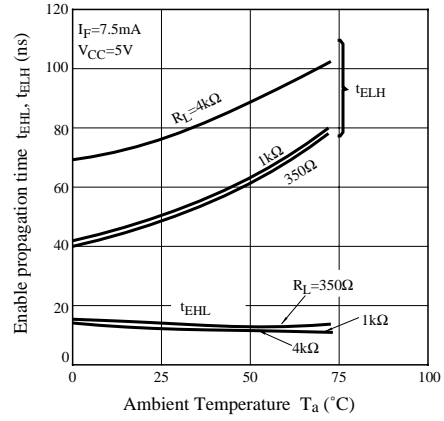
**Fig. 10 Propagation Delay Time vs. Ambient Temperature**



**Fig. 11 Rise Time, Fall Time vs. Ambient Temperature**



**Fig. 12 Enable Propagation Time vs. Ambient Temperature**



**■ Precaution for Use**

- (1) Handle this product the same as with other integrated circuits against static electricity.

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